











PRODUCT DATASHEET



- ► PCB / CHIP LED
- ► 1204SV Series (1.4t)
- ► Sky White (9900K)

N0W12S35SV









FEATURES:

• Package: Side View PCB / CHIP LED

Forward Current: 20mA
Forward Voltage (typ.): 3.1V

• Luminous Intensity (typ.): 255mcd @20mA

Colour: Sky WhiteCCT: 9900K

• Viewing angle: 150°

• Materials:

Die: InGaN

Resin: Epoxy (Yellow Diffused)
Operating Temperature: -40~+80°C

• Storage Temperature: -40~+85°C

Grouping parameters:

Forward voltage

Luminous intensity

CIE Chromaticity

Soldering methods: Reflow soldering
Preconditioning: acc. to JEDEC Level 3

• Packing: 8mm tape with 3000/reel, ø180mm (7")

APPLICATIONS:

- LED Display
- Indicator
- Traffic Display
- Decoration Lighting



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	30	mA
Peak Forward Current Duty 1/8@1KHz	I _{FP}	125	mA
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	111	mW
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+85	°C

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test	
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V_{F}	2.8	3.1	3.7	V	I _F =20mA	
Luminous Intensity	I _V	125	255	400	mcd	I _F =20mA	
Chromaticity Coordinates	Х	0.2500	0.2800	0.3300		I _F =20mA	
	Υ	0.2400	0.2900	0.3400			
Colour Temperature	ССТ	5600	9900	46500	К	I _F =20mA	
Viewing Angle	2θ _{1/2}		150		deg	I _F =20mA	

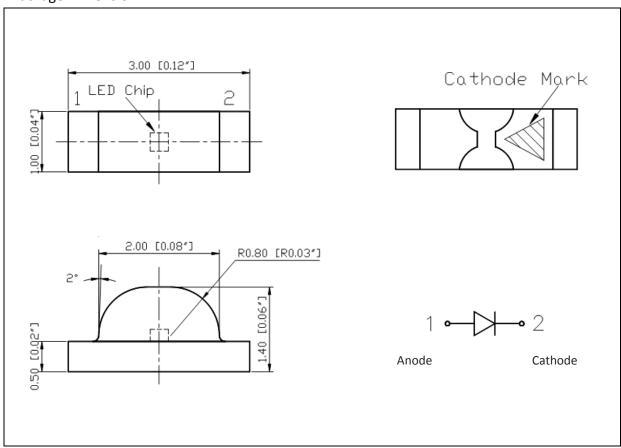
^{1.} Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V, Viewing angle(2 $\theta_{1/2}$) ±5%

^{2.} IS standard testing



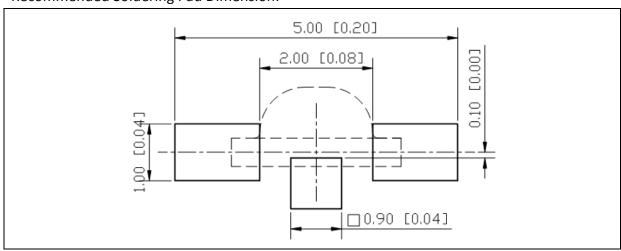
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance ± 0.5 °.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 20mA$):

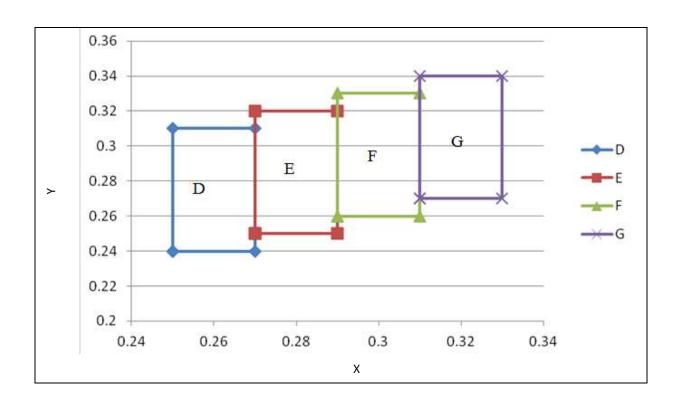
Code	Min.	Max.	Unit
F	2.8	3.1	
G	3.1	3.4	V
Н	3.4	3.7	

Luminous Intensity Classifications ($I_F = 20mA$):

Code	Min.	Max.	Unit
K	125	160	
L	160	200	
M	200	250	mcd
N	250	320	
0	320	400	



CIE CHROMATICITY DIAGRAM:

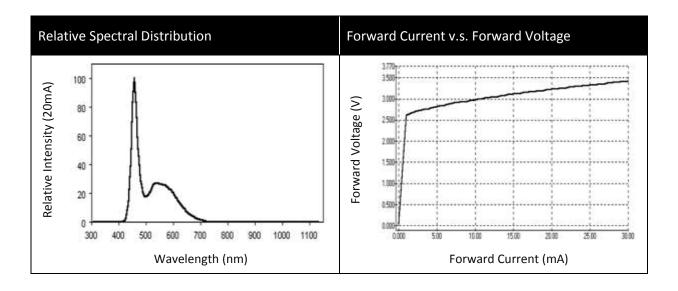


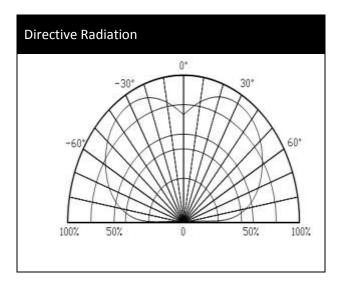
Chromaticity Coordinates Classifications (I_F = 300mA):

	1	l	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
D	0.2500	0.2400	0.2500	0.3100	0.2700	0.3100	0.2700	0.2400
Е	0.2700	0.2500	0.2700	0.3200	0.2900	0.3200	0.2900	0.2500
F	0.2900	0.2600	0.2900	0.3300	0.3100	0.3300	0.3100	0.2600
G	0.3100	0.2700	0.3100	0.3400	0.3300	0.3400	0.3300	0.2700



ELECTRO-OPTICAL CHARACTERISTICS:

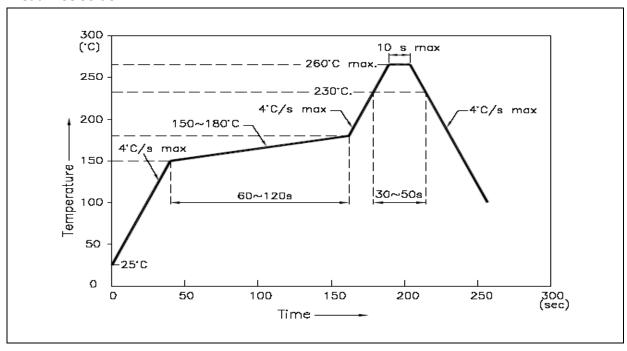






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



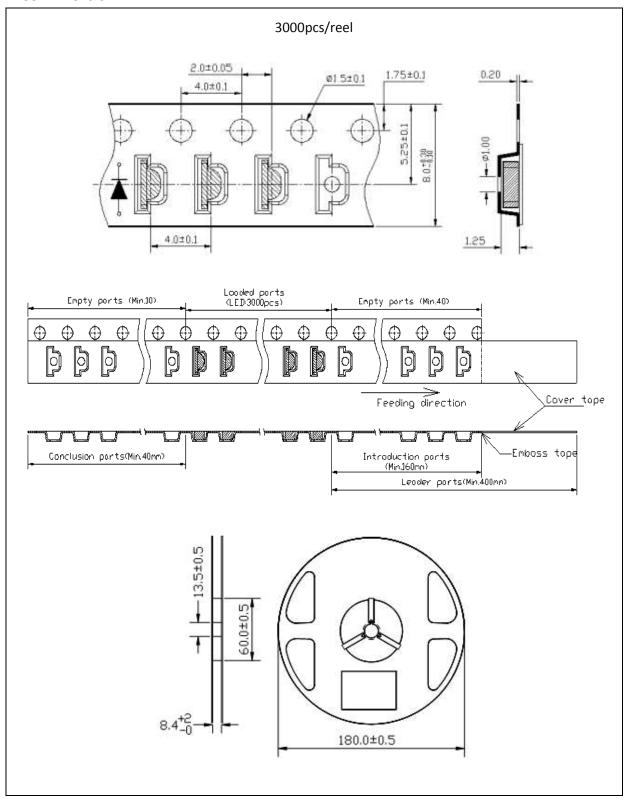
Note:

- 1. Recommend reflow temperature 245°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

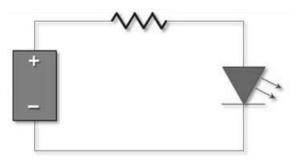
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision		
A1.0	07/08/2014	Datasheet set-up.		
A1.1	25/02/2016	Add -SV ending for side view range.		